A New Method for Determining the Size Distribution of the Working Particles in Colloidal Suspensions

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Introduction

- There are numerous processes where the size distribution of particles in colloidal suspensions influences the efficacy of the process.
- One example is chemical-mechanical planarization (CMP) slurries used in the semiconductor industry.
- The techniques presently used to determine the PSD typically only measure relative particle concentrations and often presume the shape of the distribution.
- This presentation describes a new technique that allows measurement of both size and concentration of the working particle size distribution.
- The presentation focuses on CMP slurries, but is applicable to numerous types of colloidal suspensions.

Outline

- Method description
- Measurement of "monodisperse" particles
 - Comparison to dynamic light scattering
 - Comparison of measured and claimed particle size uniformity
 - Comparison of measured concentrations
- Measurement of slurry particle size distributions
 - Comparison to dynamic light scattering
- Example of tracking slurry properties during handling
 - Comparison to dynamic light scattering
 - Comparison to large particle tail measurement
- Example of measuring filter particle retention efficiency
- Summary

Measurement method – Ultrafine atomization (UFA)



Patent pending.

Scanning mobility particle sizer (SMPS)



Differential mobility analyzer (DMA)



Condensation particle counter (CPC)



Measurement method – Ultrafine atomization (UFA)



Patent pending.

Key technical challenge

- Want to have no more than 1 particle in each droplet.
- Non-volatile <u>dissolved residue</u> in the UPW and slurry will form particles when the droplets from the atomizer are dried. These residue particles can interfere with the <u>suspended particle analysis</u>.
- The atomizer must produce small, uniformly-sized droplets to prevent interference with the particle analysis.

Droplet size distributions produced by different atomizers



Residue interference with Atomizer D



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Slide 11

Sizing of 20, 50, and 80 nm PSL particles





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Measured CV of 20nm PSL



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Comparison between claimed and measured PSL size uniformity



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Comparison to 50nm Optical Particle Counter



60nm Calibration curve



Sizing of colloidal silica



PSD in CMP slurry A – Silica particles



UFA – Dynamic Light Scattering (DLS) Comparison Silica particle slurry A



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PSD in silica particle slurry B



Measuring the effect of handling on Slurry A PSD



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Measuring the effect of handling on slurry PSD Volume weighted concentrations



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Effect of handling – comparison to dynamic light scattering (NICOMP 380ZLS)*

UFA

NICOMP



* - Particle Sizing Systems, Santa Barbara, CA.

Effect of handling – comparison to dynamic light scattering (NICOMP 380ZLS) – NICOMP normalized to UFA

UFA

NICOMP



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Change in cumulative concentrations over time during handling



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Comparison between UFA and large particle tail measurements during slurry handling



Filter retention test stand schematic



suspension

Filtrate concentrations over time



Example of filter retention over time



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Summary

- A new method for the measurement of the working particle size distribution in colloidal suspensions has been described.
- The method allows measurement of particle concentrations as well as size.
- The method was shown to:
 - Accurately size and count PSL particles of known size
 - Allow measurement of the working particles in CMP slurries
 - Agree qualitatively with dynamic light scattering measurements of slurry working particle size distributions
 - Discern changes in slurry working particle size distributions induced by handling
 - When combined with single optical particle counting this technique allows measurement of particle concentrations from ~ 15 to > 10,000 nm
 - Allow measurement of particle retention by filters down to ~ 15 nm.